RV

RoHS

High Precision Wraparound Thin Film Chip Resistors

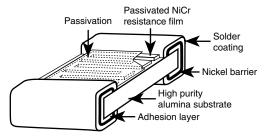
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LINKS TO ADDITIONAL RESOURCES



Utilizing proven expertise in thin film resistors, Vishay provides a chip manufactured according to CECC with the same reliability and stability found in QPL resistors. These chips are available in a wide range of sizes, values, and performance characteristics.

CONSTRUCTION



FEATURES

- Nickel barrier for high temperature operating conditions
- Tight TCR < 10 ppm/°C, and in lot tracking
 5 ppm/°C in (-55 °C, +155 °C temperature range)
- Very low noise < 35 dB and voltage coefficient 0.1 ppm/V
- Non-inductive
- Laser trimmed down to 0.1 %
- Wraparound resistance less than 0.01 Ω
- Antistatic waffle-pack or tape and reel packaging available
- High stability (0.05 % 1000 h at Pn at +70 °C)
- Withstand moisture resistance test of AEC-Q200
- According to CECC 40401-010
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

STANDA	STANDARD ELECTRICAL SPECIFICATIONS								
MODEL	SIZE	RESISTANCE RANGE ⁽¹⁾ ⁽²⁾ Ω	RATED POWER Pn W	LIMITING ELEMENT VOLTAGE (UL) V	TOLERANCE ± %	TEMPERATURE COEFFICIENT ± ppm/°C			
RV	0505	100 to 260K	0.125	50	0.1, 0.5, 1, 2, 5	10, 25			
RV	0603	100 to 260K	0.125	50	0.1, 0.5, 1, 2, 5	10, 25			
RV	0805	100 to 300K	0.200	50	0.1, 0.5, 1, 2, 5	10, 25			
RV	1206	100 to 1M	0.330	75	0.1, 0.5, 1, 2, 5	10, 25			

Notes

⁽¹⁾ Extended resistance range on request

⁽²⁾ For ohmic range versus tolerance and TCR, see detailed table

CLIMATIC SPECIFICATIONS					
Operating temperature range	-55 °C to +155 °C				
Storage temperature range	-55 °C to +155 °C				

MECHANICAL SPECIFICATIONS					
Resistive material	Nichrome				
Substrate material	Alumina				
Plating	Tin lead over nickel or tin silver over nickel or gold over nickel				
Marking resistance to solvents	Per CECC specs				

OHMIC RANGE VS. TOLERANCE AND TCR						
CASE SIZE	OHMIC RANGE Ω	TOLERANCE %	TCR ppm/°C			
0505	100 < 500	0.5; 1; 2; 5	10, 25			
0505	500 to 260K	0.1; 0.5; 1; 2; 5	10, 25			
0603	100 < 500	0.5; 1; 2; 5	10, 25			
0603	500 to 260K	0.1; 0.5; 1; 2; 5	10, 25			
0805	100 < 500	0.5; 1; 2; 5	10, 25			
0805	500 to 300K	0.1; 0.5; 1; 2; 5	10, 25			
1206	100 < 500	0.5; 1; 2; 5	10, 25			
1206	500 to 1M	0.1; 0.5; 1; 2; 5	10, 25			

Revision: 04-Oct-2021

1 For technical questions, contact: <u>sferthinfilm@vishay.com</u> Document Number: 60022

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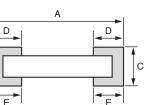
TECHNICAL SPECIFICATIONS

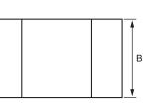
TEST	SPECIFICATIONS	CONDITIONS				
Absolute TCR	E: ± 25 ppm/°C / Y: ± 10 ppm/°C	-55 °C to +155 °C				
Absolute tolerance	± 0.1 %, ± 0.5 %, ± 1 %, ± 2 %, ± 5 % ($R \ge 500 \Omega$)					
Absolute tolerance	± 0.5 %, ± 1 %, ± 2 %, ± 5 % ($R \ge 100 \Omega$)					
Voltage coefficient	0.1 ppm/V					
Noise	-35 dB typical					
Thermal EMF	< 0.1 µV/°C					
Load life stability	± (0.1 % Rn ⁽¹⁾ ± 0.05 Ω)	1000 h Pn at +70 °C				

Note

⁽¹⁾ Rn: nominal resistance

DIMENSIONS in millimeters (inches)





SERIES /	Α		В		D/E		С	
CASE SIZES	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.
RV 0505	1.198	1.502	1.143	1.397	0.250	0.510	0.373	0.627
	(0.047)	(0.059)	(0.045)	(0.055)	(0.010)	(0.020)	(0.015)	(0.025)
RV 0603	1.368	1.672	0.623	0.877	0.250	0.510	0.373	0.627
	(0.054)	(0.066)	(0.025)	(0.035)	(0.010)	(0.020)	(0.015)	(0.025)
RV 0805	1.758	2.062	1.143	1.397	0.250	0.510	0.373	0.627
	(0.069)	(0.081)	(0.045)	(0.055)	(0.010)	(0.020)	(0.015)	(0.025)
RV 1206	2.908	3.212	1.473	1.727	0.250	0.510	0.373	0.627
	(0.114)	(0.126)	(0.058)	(0.068)	(0.010)	(0.020)	(0.015)	(0.025)

POPULAR OPTION

AEC-Q200 moisture resistance

Option to order: 0058: specific production process to withstand 85 °C / 85 % RH at Pn/10

ENVIRONMENTAL TEST						
TEST	CONDITIONS	VALUES AND DRIFTS (∆R/R ± %)				
TEST	CONDITIONS	CECC REQUIREMENTS	TYPICAL PERFORMANCE			
Overload	6.25 x rated power / 2 s (or 2 UL)	0.05 % Rn ⁽²⁾ + 0.05 Ω	0.01 % Rn ⁽²⁾			
Climatic sequences (1)	-55 °C / +155 °C 5 moisture cycles	0.1 % Rn $^{(2)}$ + 0.05 Ω	0.02 % Rn ⁽²⁾			
Thermal shock ⁽¹⁾	-55 °C / +155 °C 5 cycles 30 min	0.05 % Rn $^{(2)}$ + 0.05 Ω	0.02 % Rn ⁽²⁾			
Load life ⁽¹⁾	+70 °C/Pn 1000 h	0.1 % Rn $^{(2)}$ + 0.05 Ω	0.05 % Rn ⁽²⁾			
Resistance to solder heat	+260 °C/ 10 s	0.05 % Rn ⁽²⁾ + 0.05 Ω	0.02 % Rn ⁽²⁾			
	+40 °C / 93 % HR Pn/10	0.1 % Rn $^{(2)}$ + 0.05 Ω	0.01 % Rn ⁽²⁾			
Moisture resistance ⁽¹⁾	AEC-Q200 ⁽³⁾ 85 °C / 85 % RH / Pn/10 1000 h	0.5 % + 0.05 Ω	Max. < 0.3 % + 0.05 Ω			
High temperature storage	1000 h at + 155 °C	0.1 % Rn ⁽²⁾ + 0.05 Ω	0.05 % Rn ⁽²⁾			
Bending ⁽¹⁾	10 bends / 2 mm / 5 s	0.05 % Rn $^{(2)}$ + 0.05 Ω	0.02 % Rn ⁽²⁾			

Notes

(1) Test requiring parts to be mounted on PCB will be performed with the requirement that termination alloy will be the same as solder paste alloy. Gold termination will be tested as B termination

Rn: nominal resistance Pn: nominal power (2)

⁽³⁾ Option to order: 0058

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SPECIFIC CONDITIONS DUE TO TERMINATION TYPE								
TEST	COND	ITIONS	VALUES AND DRIFTS					
TEST	B; G	N	VISHAY REQUIREMENTS	TYPICAL PERFORMANCE				
Solderability	+235 °C/2 s Sn60Pb40 alloy	+245 °C/3 s Sn97Ag3 alloy	VISUAL INSPECTION					
High T° reflow profile	N/A	+255 °C/40 s (on parts)	0.02 % Rn ⁽¹⁾ + 0.05 Ω 0.01 % Rn ⁽¹⁾ + 0.05					

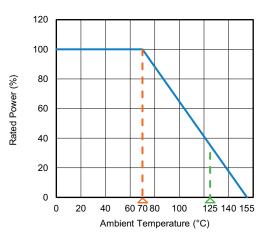
Note

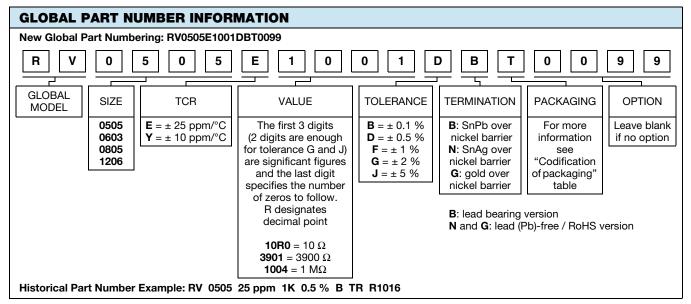
(1) Rn: nominal resistance

Pn: nominal power

PACKAGING INFORMATION							
	NUMBER OF PIECES PER PACKAGE						
SIZE	WAFFLE PACK	TAPE AN	TAPE				
	(2" x 2")	MIN.	MAX.	WIDTH			
0505	100		4000				
0603	100	100	5000	8 mm			
0805	100	100	4000	(0.315")			
1206	140		4000				

DERATING CURVE





PART NUM	BER DESC	RIPTION (fo	or information or	nly)			
RV	0505	25 ppm	1K	0.5 %	В	TR	R1016
MODEL	SIZE	TCR	OHMIC VALUE	TOLERANCE	TERMINATION	PACKAGING	OPTION

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CODIFICATION OF PACKAGING					
CODE 18	PACKAGING				
WAFFLE PACK					
W	100 min., 1 mult.				
WA	100 min., 100 mult. (available only in size 1206)				
PLASTIC TAPE (Standard for all s	sizes.)				
Т	100 min., 1 mult.				
ТА	100 min., 100 mult.				
ТВ	250 min., 250 mult.				
тс	500 min., 500 mult.				
TD	1000 min., 1000 mult.				
TE	2500 min., 2500 mult.				
TF	Full tape (quantity depending on size of chips)				
PAPER TAPE (Available for 0603,	0805, and 1206. Please consult Vishay Sfernice for other sizes.)				
PT	100 min., 1 mult.				
PA	100 min., 100 mult.				
РВ	250 min., 250 mult.				
PC	500 min., 500 mult.				
PD	1000 min., 1000 mult.				
PE	2500 min., 2500 mult.				
PF	Full tape (quantity depending on size of chips)				



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